HEF4053B

Triple single-pole double-throw analog switch Rev. 11 — 11 September 2014

Product data sheet

1. **General description**

The HEF4053B is a triple single-pole double-throw (SPDT) analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. Each switch has a digital select input (Sn), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ). All three switches share an enable input (\overline{E}) . A HIGH on \overline{E} causes all switches into the high-impedance OFF-state, independent of Sn.

V_{DD} and V_{SS} are the supply voltage connections for the digital control inputs (Sn and E). The V_{DD} to V_{SS} range is 3 V to 15 V. The analog inputs/outputs (nY0, nY1 and nZ) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. $V_{DD} - V_{EE}$ may not exceed 15 V. Unused inputs must be connected to V_{DD}, V_{SS}, or another input. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground). V_{EE} and V_{SS} are the supply voltage connections for the switches.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from –40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. **Applications**

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

Ordering information

Table 1. **Ordering information**

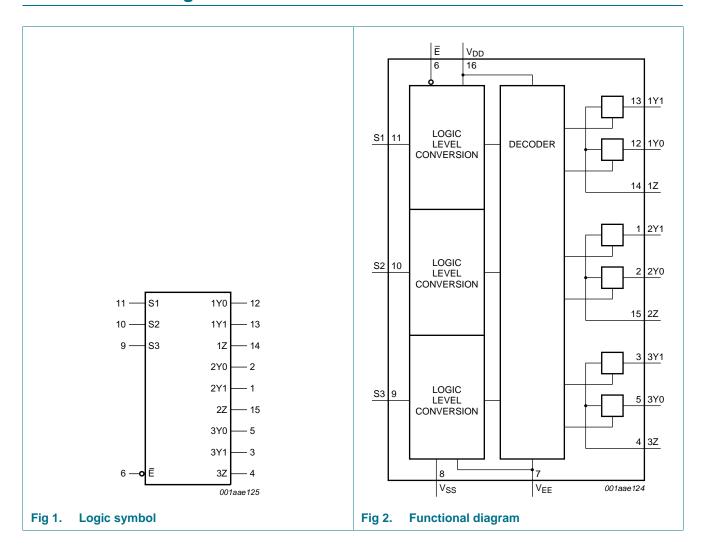
All types operate from $-40 \,^{\circ}\text{C}$ to $+125 \,^{\circ}\text{C}$.

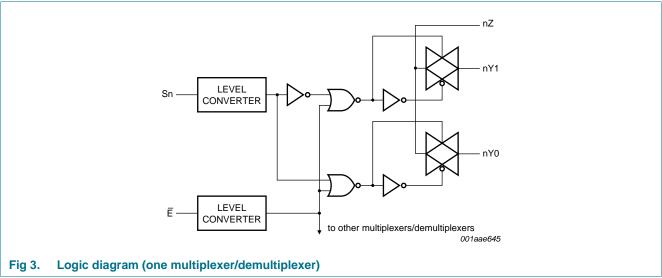
| Type number | Package | | | | | | |
|-------------|---------|--|----------|--|--|--|--|
| | Name | Description | | | | | |
| HEF4053BP | DIP16 | plastic dual in-line package; 16 leads (300 mil) | SOT38-4 | | | | |
| HEF4053BT | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 | | | | |
| HEF4053BTT | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 | | | | |



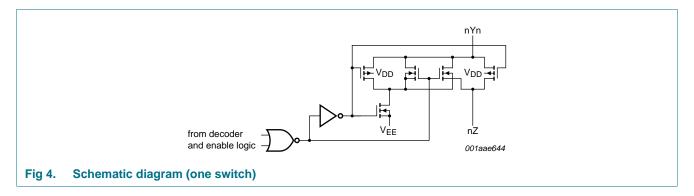
Triple single-pole double-throw analog switch

5. Functional diagram



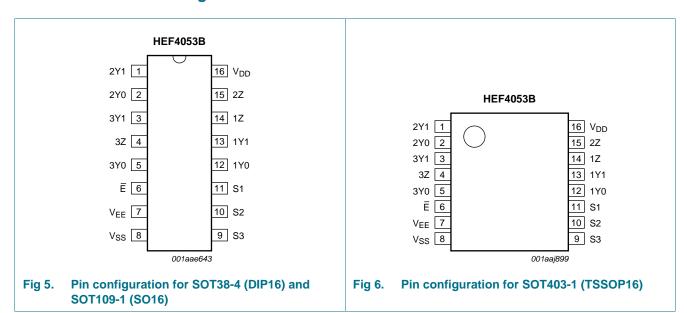


Triple single-pole double-throw analog switch



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|-----------|-----------------------------|
| Ē | 6 | enable input (active LOW) |
| V _{EE} | 7 | supply voltage |
| V _{SS} | 8 | ground supply voltage |
| S1, S2, S3 | 11, 10, 9 | select input |
| 1Y0, 2Y0, 3Y0 | 12, 2, 5 | independent input or output |
| 1Y1, 2Y1, 3Y1 | 13, 1, 3 | independent input or output |
| 1Z, 2Z, 3Z | 14, 15, 4 | independent output or input |
| V_{DD} | 16 | supply voltage |

Triple single-pole double-throw analog switch

7. Functional description

Table 3. Function table [1]

| Inputs | Channel on | |
|--------|------------|--------------|
| Ē | Sn | |
| L | L | nY0 to nZ |
| L | Н | nY1 to nZ |
| Н | X | switches OFF |

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{SS} = 0 V (ground).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|---|------------|------|-----------------------|------|
| V_{DD} | supply voltage | | | -0.5 | +18 | V |
| V _{EE} | supply voltage | referenced to V _{DD} | <u>[1]</u> | -18 | +0.5 | V |
| I _{IK} | input clamping current | pins Sn and \overline{E} ; V _I < -0.5 V or V _I > V _{DD} + 0.5 V | | - | ±10 | mA |
| VI | input voltage | | | -0.5 | V _{DD} + 0.5 | V |
| I _{I/O} | input/output current | | | - | ±10 | mA |
| I _{DD} | supply current | | | - | 50 | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| T _{amb} | ambient temperature | | | -40 | +125 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [2] | | | |
| | | DIP16 package | | - | 750 | mW |
| | | SO16 package | | - | 500 | mW |
| | | TSSOP16 package | | - | 500 | mW |
| Р | power dissipation | per output | | - | 100 | mW |

^[1] To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE}.

9. Recommended operating conditions

Table 5. Recommended operating conditions

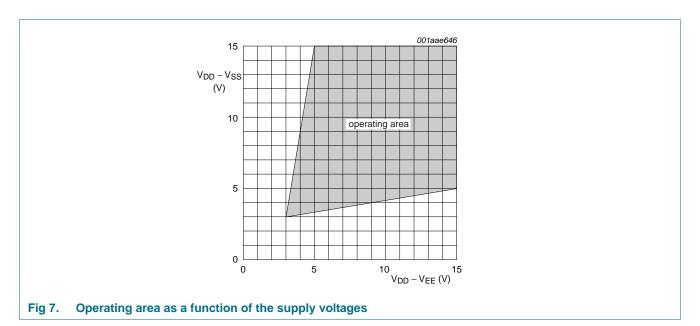
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---------------------|--------------|-----|-----|----------|------|
| V_{DD} | supply voltage | see Figure 7 | 3 | - | 15 | V |
| VI | input voltage | | 0 | - | V_{DD} | V |
| T _{amb} | ambient temperature | in free air | -40 | - | +125 | °C |

^[2] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C. For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C. For TSSOP16 package: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

Triple single-pole double-throw analog switch

 Table 5.
 Recommended operating conditions ...continued

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------|--------------------------------|------------------------|-----|-----|------|------|
| Δt/ΔV | input transition rise and fall | $V_{DD} = 5 V$ | - | - | 3.75 | μs/V |
| | rate | V _{DD} = 10 V | - | - | 0.5 | μs/V |
| | | V _{DD} = 15 V | - | - | 0.08 | μs/V |



10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = V_{EE} = 0 \ V$; $V_I = V_{SS} \ or \ V_{DD} \ unless \ otherwise \ specified.$

| Symbol | Parameter | Conditions | V_{DD} | T _{amb} = | –40 °C | T _{amb} = | 25 °C | T _{amb} = | 85 °C | T _{amb} = | 125 °C | Unit |
|---------------------|----------------------------------|---|----------|--------------------|--------|--------------------|-------|--------------------|-------|--------------------|--------|------|
| | | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| V_{IH} | HIGH-level | HIGH-level $ I_O < 1 \mu A$ nput voltage | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | 3.5 | - | V |
| | input voltage | | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | 7.0 | - | V |
| | | | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | 11.0 | - | V |
| V_{IL} | LOW-level | I _O < 1 μA | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | - | 1.5 | V |
| | input voltage | input voltage | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | - | 3.0 | V |
| | | | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | - | 4.0 | V |
| II | input leakage current | | 15 V | - | ±0.1 | - | ±0.1 | - | ±1.0 | - | ±1.0 | μΑ |
| I _{S(OFF)} | S(OFF) OFF-state leakage current | Z port; all channels OFF; see <u>Figure 8</u> | 15 V | - | - | - | 1000 | - | - | - | - | nA |
| | | Y port; per channel; see <u>Figure 9</u> | 15 V | - | - | - | 200 | - | - | - | - | nA |

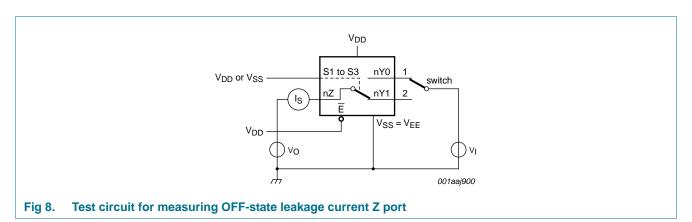
Triple single-pole double-throw analog switch

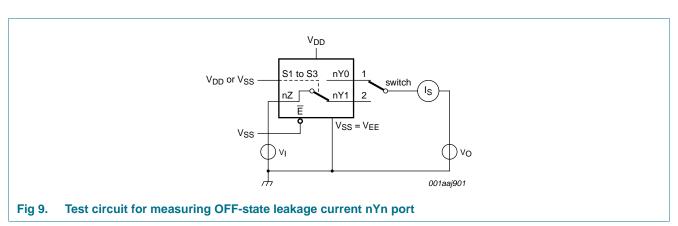
 Table 6.
 Static characteristics ...continued

 $V_{SS} = V_{EE} = 0 \text{ V}; V_I = V_{SS} \text{ or } V_{DD} \text{ unless otherwise specified.}$

| Symbol | Parameter | Conditions | V_{DD} | T _{amb} = | –40 °C | T _{amb} = | 25 °C | T _{amb} = | 85 °C | T _{amb} = | 125 °C | Unit |
|--------------------------------|---------------------------|--------------|----------|--------------------|--------|--------------------|-------|--------------------|-------|--------------------|--------|------|
| | | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| I _{DD} supply current | rent I _O = 0 A | 5 V | - | 5 | - | 5 | - | 150 | - | 150 | μΑ | |
| | | | 10 V | - | 10 | - | 10 | - | 300 | - | 300 | μΑ |
| | | | 15 V | - | 20 | - | 20 | - | 600 | - | 600 | μΑ |
| Cı | input capacitance | Sn, E inputs | - | - | - | - | 7.5 | - | - | - | - | pF |

10.1 Test circuits





10.2 ON resistance

Table 7. ON resistance

 $T_{amb} = 25$ °C; $I_{SW} = 200~\mu A$; $V_{SS} = V_{EE} = 0~V$.

| Symbol | Parameter | Conditions | $V_{DD} - V_{EE}$ | Тур | Max | Unit |
|-----------------------|----------------------|--|-------------------|-----|------|------|
| R _{ON(peak)} | ON resistance (peak) | $V_I = 0 V \text{ to } V_{DD} - V_{EE};$ | 5 V | 350 | 2500 | Ω |
| | | see Figure 10 and Figure 11 | 10 V | 80 | 245 | Ω |
| | | | 15 V | 60 | 175 | Ω |

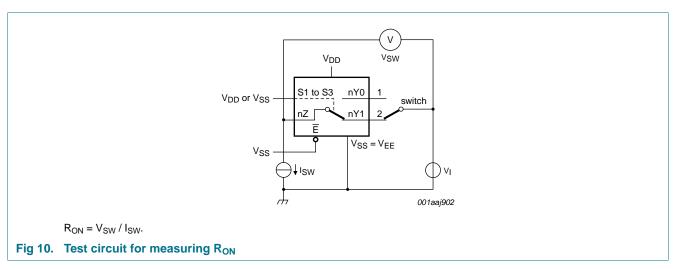
Triple single-pole double-throw analog switch

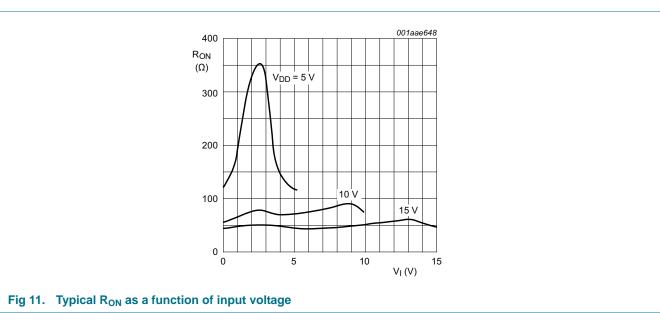
 Table 7.
 ON resistance ...continued

 $T_{amb} = 25$ °C; $I_{SW} = 200 \mu A$; $V_{SS} = V_{EE} = 0 \text{ V}$.

| Symbol | Parameter | Conditions | $V_{DD} - V_{EE}$ | Тур | Max | Unit |
|-----------------------|------------------------|---|-------------------|-----|-----|------|
| R _{ON(rail)} | ON resistance (rail) | V _I = 0 V; see <u>Figure 10</u> and <u>Figure 11</u> | 5 V | 115 | 340 | Ω |
| | | | 10 V | 50 | 160 | Ω |
| | | | 15 V | 40 | 115 | Ω |
| | | $V_I = V_{DD} - V_{EE};$ | 5 V | 120 | 365 | Ω |
| | | see Figure 10 and Figure 11 | 10 V | 65 | 200 | Ω |
| | | | 15 V | 50 | 155 | Ω |
| ΔR_{ON} | ON resistance mismatch | $V_I = 0 \text{ V to } V_{DD} - V_{EE}$; see <u>Figure 10</u> | 5 V | 25 | - | Ω |
| | between channels | | 10 V | 10 | - | Ω |
| | | | 15 V | 5 | - | Ω |

10.2.1 ON resistance waveform and test circuit





Triple single-pole double-throw analog switch

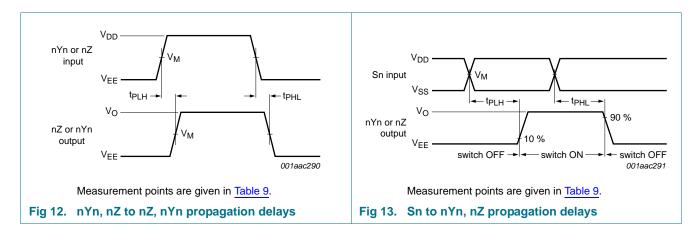
11. Dynamic characteristics

Table 8. Dynamic characteristics

 $T_{amb} = 25$ °C; $V_{SS} = V_{EE} = 0$ V; for test circuit see <u>Figure 15</u>.

| Symbol | Parameter | Conditions | V_{DD} | Тур | Max | Unit |
|--|-------------------------------|-----------------------------------|----------|-----|-----|------|
| t _{PHL} | HIGH to LOW propagation delay | nYn, nZ to nZ, nYn; see Figure 12 | 5 V | 10 | 20 | ns |
| | | | 10 V | 5 | 10 | ns |
| | | | 15 V | 5 | 10 | ns |
| | | Sn to nYn, nZ; see Figure 13 | 5 V | 200 | 400 | ns |
| | | | 10 V | 85 | 170 | ns |
| | | | 15 V | 65 | 130 | ns |
| t _{PLH} LOW to HIGH propagation delay | LOW to HIGH propagation delay | nYn, nZ to nZ, nYn; see Figure 12 | 5 V | 15 | 30 | ns |
| | | 10 V | 5 | 10 | ns | |
| | | | 15 V | 5 | 10 | ns |
| | | Sn to nYn, nZ; see Figure 13 | 5 V | 275 | 555 | ns |
| | | | 10 V | 100 | 200 | ns |
| | | | 15 V | 65 | 130 | ns |
| t _{PHZ} | HIGH to OFF-state | E to nYn, nZ; see Figure 14 | 5 V | 200 | 400 | ns |
| | propagation delay | | 10 V | 115 | 230 | ns |
| | | | 15 V | 110 | 220 | ns |
| t _{PZH} | OFF-state to HIGH | E to nYn, nZ; see Figure 14 | 5 V | 260 | 525 | ns |
| | propagation delay | | 10 V | 95 | 190 | ns |
| | | | 15 V | 65 | 130 | ns |
| PLZ | LOW to OFF-state | E to nYn, nZ; see Figure 14 | 5 V | 200 | 400 | ns |
| | propagation delay | | 10 V | 120 | 245 | ns |
| | | | 15 V | 110 | 215 | ns |
| t _{PZL} | OFF-state to LOW | E to nYn, nZ; see Figure 14 | 5 V | 280 | 565 | ns |
| | propagation delay | | 10 V | 105 | 205 | ns |
| | | | 15 V | 70 | 140 | ns |

11.1 Waveforms and test circuit



Triple single-pole double-throw analog switch

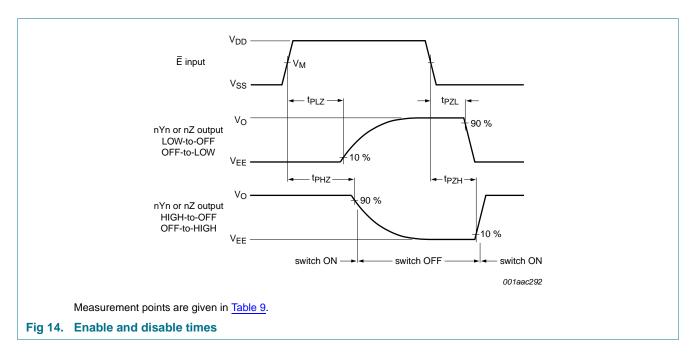
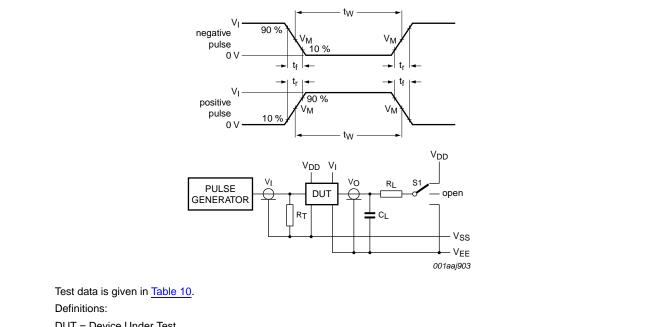


Table 9. Measurement points

| Supply voltage | Input | Output |
|----------------|--------------------|--------------------|
| V_{DD} | V _M | V _M |
| 5 V to 15 V | 0.5V _{DD} | 0.5V _{DD} |

Triple single-pole double-throw analog switch



DUT = Device Under Test.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 C_L = Load capacitance including test jig and probe.

R_L = Load resistance.

Fig 15. Test circuit for measuring switching times

Table 10. Test data

| Input | put | | | | oad S1 position | | | | | | |
|----------------------|----------------------|---------------------------------|--------------------|----------------|-----------------|----------------------|------------------|-------------------------------------|--------------------|-----------------|--|
| nYn, nZ | Sn and E | t _r , t _f | V _M | C _L | R_L | t _{PHL} [1] | t _{PLH} | t _{PZH} , t _{PHZ} | t_{PZL}, t_{PLZ} | other | |
| V_{DD} or V_{EE} | V_{DD} or V_{SS} | ≤ 20 ns | 0.5V _{DD} | 50 pF | 10 kΩ | V_{DD} or V_{EE} | V _{EE} | V _{EE} | V_{DD} | V _{EE} | |

[1] For nYn to nZ or nZ to nYn propagation delays use V_{EE} . For Sn to nYn or nZ propagation delays use V_{DD} .

Triple single-pole double-throw analog switch

11.2 Additional dynamic parameters

Table 11. Additional dynamic characteristics

 $V_{SS} = V_{EE} = 0$ V; $T_{amb} = 25$ °C.

| Symbol | Parameter | Conditions | V_{DD} | | Тур | Max | Unit |
|---------------------|---------------------------|---|----------|------------|------|-----|------|
| THD | total harmonic distortion | see Figure 16; $R_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; | 5 V | <u>[1]</u> | 0.25 | - | % |
| | | channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1 \text{ kHz}$ | 10 V | <u>[1]</u> | 0.04 | - | % |
| | | II = I KMZ | 15 V | <u>[1]</u> | 0.04 | - | % |
| f _(-3dB) | -3 dB frequency response | see Figure 17; $R_L = 1 \text{ k}\Omega$; $C_L = 5 \text{ pF}$; | 5 V | <u>[1]</u> | 13 | - | MHz |
| | | channel ON; $V_I = 0.5V_{DD}$ (p-p) | 10 V | <u>[1]</u> | 40 | - | MHz |
| | | | 15 V | <u>[1]</u> | 70 | - | MHz |
| α_{iso} | isolation (OFF-state) | see Figure 18; f_i = 1 MHz; R_L = 1 k Ω ; C_L = 5 pF; channel OFF; V_I = 0.5 V_{DD} (p-p) | 10 V | [1] | -50 | - | dB |
| V _{ct} | crosstalk voltage | digital inputs to switch; see Figure 19; $\underline{R}_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; \overline{E} or $Sn = V_{DD}$ (square-wave) | 10 V | | 50 | - | mV |
| Xtalk | crosstalk | between switches; see Figure 20; $f_i = 1$ MHz; $R_L = 1$ k Ω ; $V_I = 0.5V_{DD}$ (p-p) | 10 V | [1] | -50 | - | dB |

^[1] f_i is biased at 0.5 V_{DD} ; $V_I = 0.5 V_{DD}$ (p-p).

Table 12. Dynamic power dissipation P_D

 P_D can be calculated from the formulas shown; $V_{EE} = V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

| Symbol | Parameter | V_{DD} | Typical formula for P _D (μW) | where: |
|--------|---------------|----------|--|---|
| P_D | dynamic power | 5 V | $P_D = 2500 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$ | f_i = input frequency in MHz; |
| | dissipation | 10 V | $P_D = 11500 \times f_i + \Sigma (f_0 \times C_L) \times V_{DD}^2$ | f _o = output frequency in MHz; |
| | | 15 V | $P_D = 29000 \times f_i + \Sigma (f_0 \times C_L) \times V_{DD}^2$ | C_L = output load capacitance in pF; |
| | | | | V _{DD} = supply voltage in V; |
| | | | | $\Sigma(C_L \times f_o) = \text{sum of the outputs.}$ |

11.2.1 Test circuits

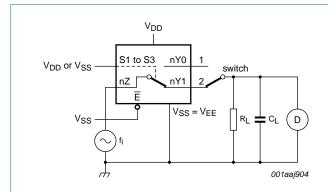


Fig 16. Test circuit for measuring total harmonic distortion

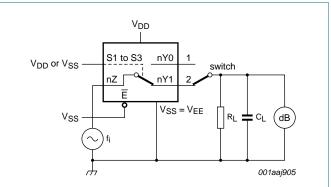
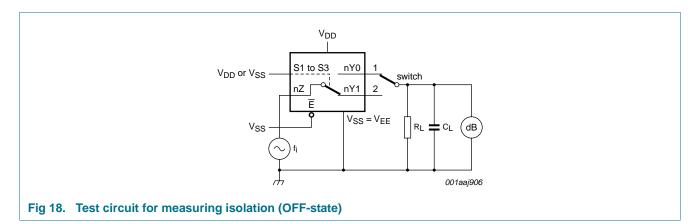
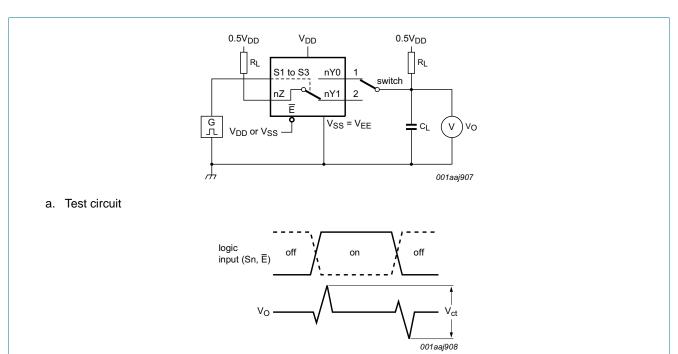


Fig 17. Test circuit for measuring frequency response

Triple single-pole double-throw analog switch

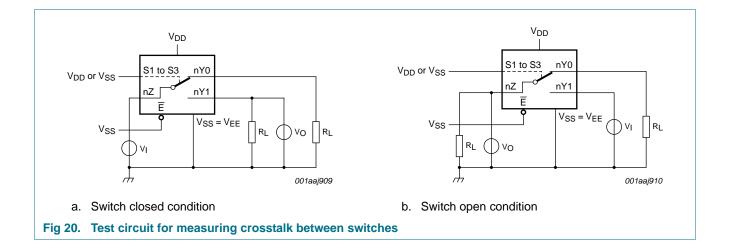




b. Input and output pulse definitions

Fig 19. Test circuit for measuring crosstalk voltage between digital inputs and switch

Triple single-pole double-throw analog switch

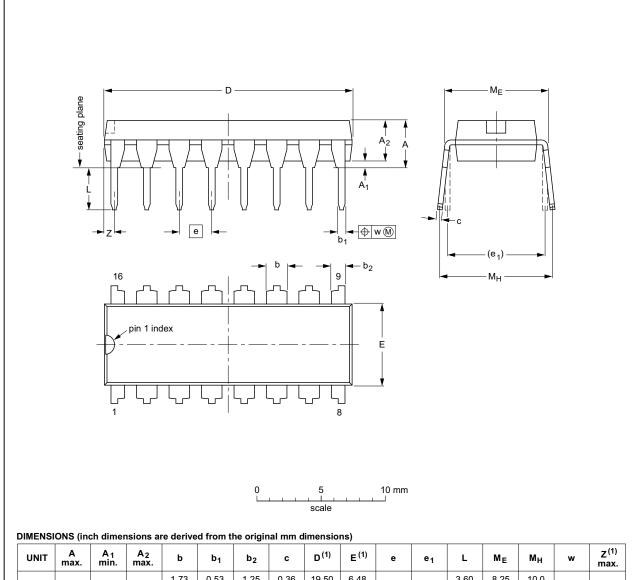


Triple single-pole double-throw analog switch

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | b ₂ | С | D ⁽¹⁾ | E ⁽¹⁾ | е | e ₁ | L | ME | M _H | w | Z ⁽¹⁾ max. |
|--------|-----------|---------------------|------------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|--------------|----------------|-------|--------------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 1.25 0.85 | 0.36 0.23 | 19.50 18.55 | 6.48 6.20 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 0.76 |
| inches | 0.17 | 0.02 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.049 0.033 | 0.014 0.009 | 0.77 0.73 | 0.26 0.24 | 0.1 | 0.3 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.03 |

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

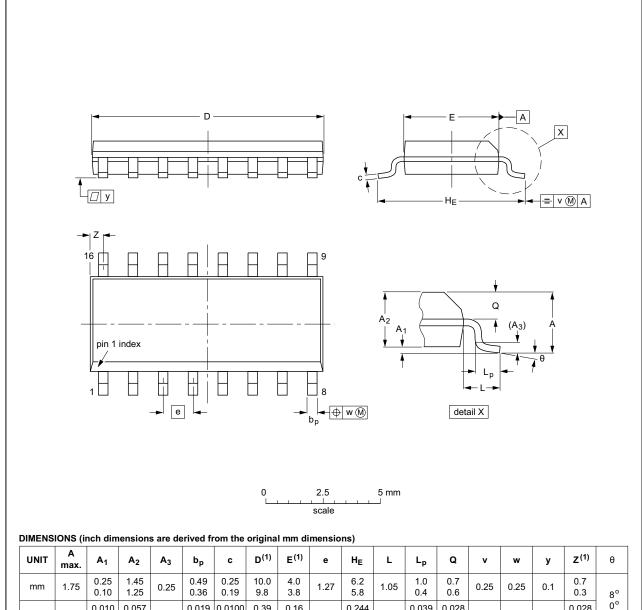
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | |
|---------|-----|-------|----------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE |
| SOT38-4 | | | | | 95-01-14 03-02-13 |

Fig 21. Package outline SOT38-4 (DIP16)

Triple single-pole double-throw analog switch

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | ٧ | w | у | Z ⁽¹⁾ | θ |
|--------|-----------|----------------|----------------|-----------------------|--------------|------------------|------------------|------------------|------|----------------|-------|----------------|------------|------|------|-------|------------------|----|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 10.0 9.8 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° |
| inches | 0.069 | 0.010 0.004 | 0.057 0.049 | 0.01 | | 0.0100 0.0075 | | 0.16 0.15 | 0.05 | 0.244 0.228 | 0.041 | 0.039 0.016 | 1 | 0.01 | 0.01 | 0.004 | 0.028 0.012 | 0° |

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

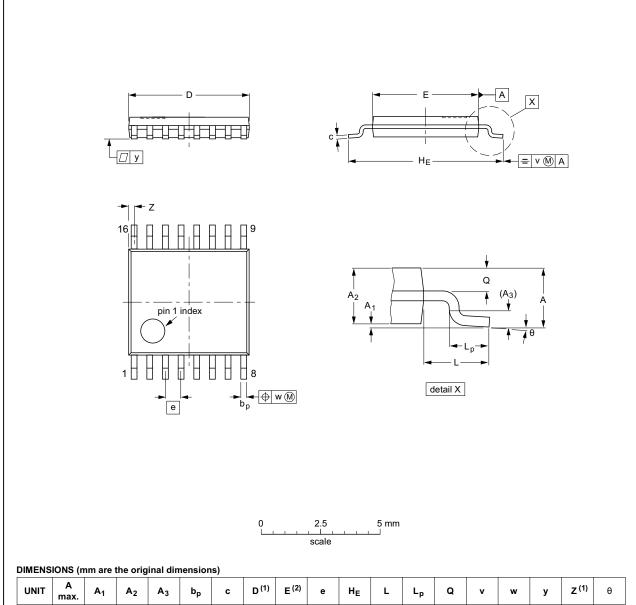
| EUROPEAN ISSUE DATE | REFERENCES | | | | | | |
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| PROJECTION ISSUE DATE | JEITA | JEDEC | IEC | VERSION | | | |
| 99-12-27 03-02-19 | | MS-012 | 076E07 | SOT109-1 | | | |
| _ | | MS-012 | 076E07 | SOT109-1 | | | |

Fig 22. Package outline SOT109-1 (SO16)

Triple single-pole double-throw analog switch

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E (2) | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|-----------------------|----------------|-----------------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.40 0.06 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| C JEIT | PROJECTION | ISSUE DATE |
|--------|------------|---------------------------------|
| | ^ | |
| 53 | | 99-12-27 03-02-18 |
| | 53 | 53 |

Fig 23. Package outline SOT403-1 (TSSOP16)

Triple single-pole double-throw analog switch

13. Abbreviations

Table 13. Abbreviations

| Acronym | Description |
|---------|-------------------|
| DUT | Device Under Test |

14. Revision history

Table 14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|--------------------------------|------------------------------|------------------------|------------------|
| HEF4053B v.11 | 20140911 | Product data sheet | - | HEF4053B v.10 |
| Modifications: | • <u>Figure 19</u> : 7 | Test circuit modified | | |
| HEF4053B v.10 | 20111117 | Product data sheet | - | HEF4053B v.9 |
| Modifications: | Legal pages | s updated. | | |
| | Changes in | "General description", "Feat | ures and benefits" and | "Applications". |
| HEF4053B v.9 | 20100325 | Product data sheet | - | HEF4053B v.8 |
| HEF4053B v.8 | 20100224 | Product data sheet | - | HEF4053B v.7 |
| HEF4053B v.7 | 20091127 | Product data sheet | - | HEF4053B v.6 |
| HEF4053B v.6 | 20090924 | Product data sheet | - | HEF4053B v.5 |
| HEF4053B v.5 | 20090825 | Product data sheet | - | HEF4053B v.4 |
| HEF4053B v.4 | 20090713 | Product data sheet | - | HEF4053B_CNV v.3 |
| HEF4053B_CNV v.3 | 19950101 | Product specification | - | HEF4053B_CNV v.2 |
| HEF4053B_CNV v.2 | 19950101 | Product specification | - | - |

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| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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17. Contents

| 1 | General description 1 |
|---------------------|--|
| 2 | Features and benefits 1 |
| 3 | Applications |
| 4 | Ordering information 1 |
| 5 | Functional diagram 2 |
| 6 | Pinning information |
| 6.1 | Pinning |
| 6.2 | Pin description |
| 7 | Functional description 4 |
| 8 | Limiting values 4 |
| 9 | Recommended operating conditions 4 |
| 10 | Static characteristics 5 |
| 10.1 | Test circuits |
| 10.2 | ON resistance |
| 10.2.1 | ON resistance waveform and test circuit 7 |
| 11 | Dynamic characteristics 8 |
| 11.1 | Waveforms and test circuit |
| 11.2 11.2.1 | Additional dynamic parameters |
| 11.∠.1 12 | Package outline |
| 13 | |
| . • | Abbreviations |
| 14 | Revision history |
| 15 | Legal information |
| 15.1 | Data sheet status |
| 15.2 15.3 | Definitions |
| 15.3 15.4 | Disclaimers 18 Trademarks 19 |
| 16.4 | Contact information |
| . • | |
| 17 | Contents |

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